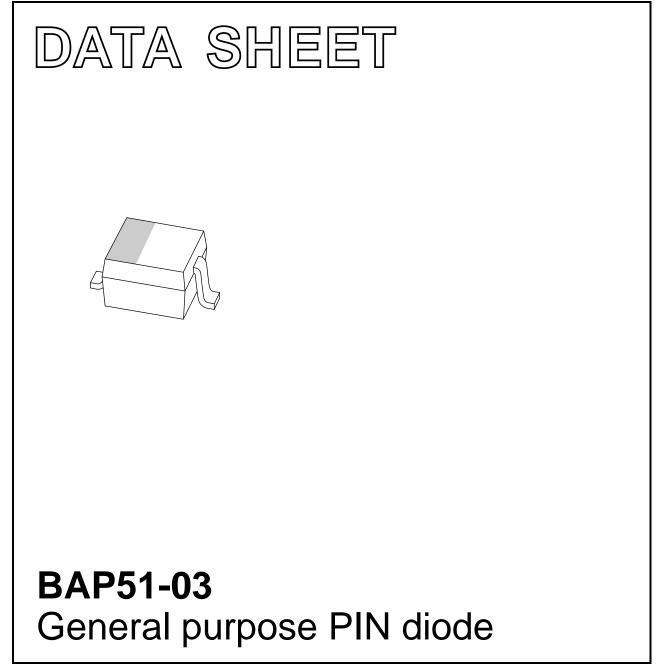
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 Aug 16 2004 Feb 11



FEATURES

- Low diode capacitance
- Low diode forward resistance.

APPLICATIONS

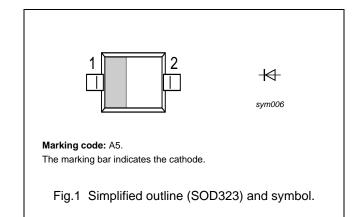
• General RF applications.

DESCRIPTION

General purpose PIN diode in a SOD323 small plastic SMD package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	



ORDERING INFORMATION

TYPE	PACKAGE		
NUMBER	NAME DESCRIPTION VE		VERSION
BAP51-03	_	plastic surface mounted package; 2 leads	SOD323

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		_	50	V
I _F	continuous forward current		_	50	mA
P _{tot}	total power dissipation	T _S = 90 °C	-	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

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ELECTRICAL CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 50 mA	-	0.95	1.1	V
V _R	reverse voltage	I _R = 10 μA	50	-	_	V
I _R	reverse current	V _R = 50 V	-	-	100	nA
C _d	diode capacitance	V _R = 0; f = 1 MHz	-	0.4	-	pF
		V _R = 1 V; f = 1 MHz	_	0.3	0.55	pF
		V _R = 5 V; f = 1 MHz	-	0.2	0.35	pF
r _D	diode forward resistance	I _F = 0.5 mA; f = 100 MHz; note 1	-	5.5	9	Ω
		I _F = 1 mA; f = 100 MHz; note 1	_	3.6	6.5	Ω
		I _F = 10 mA; f = 100 MHz; note 1	-	1.5	2.5	Ω
τ∟	charge carrier life time	when switched from $I_F = 10$ mA to	_	550	_	ns
		$I_R = 6 \text{ mA}; R_L = 100 \Omega; \text{measured}$ at $I_R = 3 \text{ mA}$				

Note

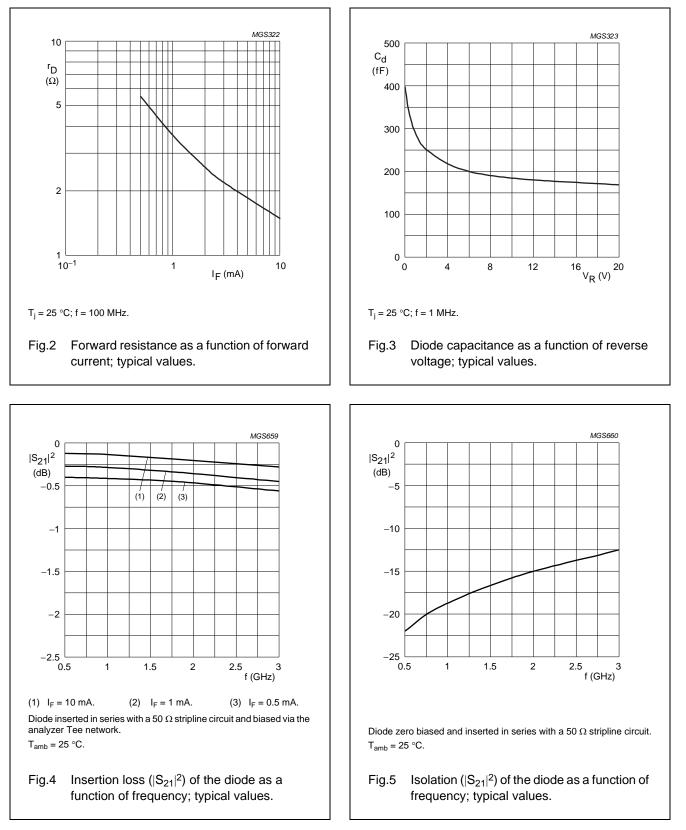
1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th(j-s)}	thermal resistance from junction to soldering point		K/W

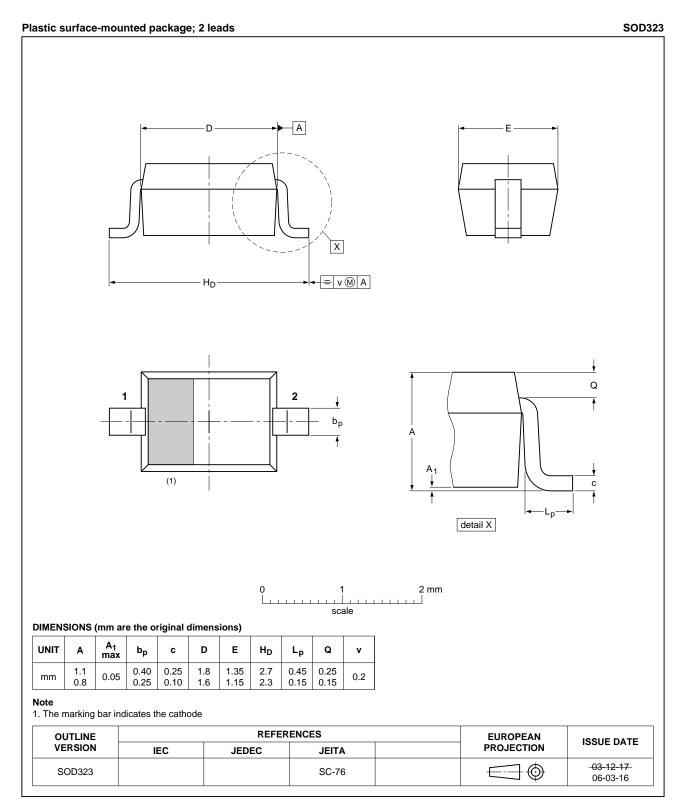
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GRAPHICAL DATA



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PACKAGE OUTLINE



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DATA SHEET STATUS	
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DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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